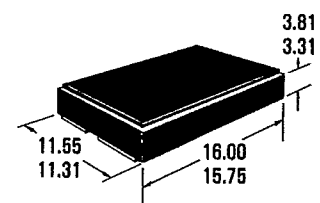
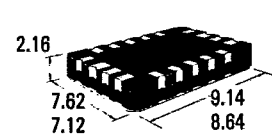
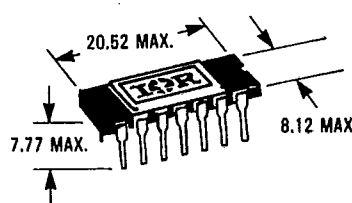
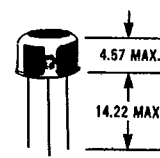
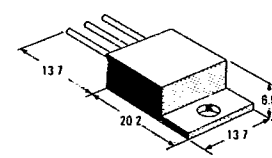
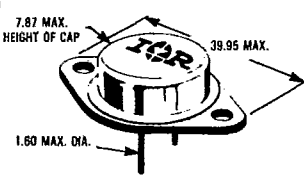


RADIATION HARD HEXFETS N-CANNEL

Types	V _{DS} V	R _{DS(ON)} (max) Ω	I _{D cont} T _C = 25°C A	I _{DM} pulsed A	P _D max W	Bulletin	Case Style
SURFACE MOUNT DEVICE — SMD-1							<p>SMD-1</p> 
IRHN150	100	0.065	25.0	100	75	—	
IRHN250	200	0.110	18.5	80	75	—	
IRHN450	500	0.450	8.0	50	75	—	
SURFACE MOUNT DEVICE — LCC							<p>LCC</p> 
IRHE120	100	0.32	6.0	20	20	—	
IRHE130	100	0.20	8.0	25	25	—	
SIDE BRAZE CERAMIC — MO-036B Package							<p>MO-036B</p> 
IRHG110	100	0.80	0.95	2.5	—	—	
TO-39 Package							<p>TO-205AF (TO-39)</p> 
IRHF130	100	0.20	8.0	32	25	—	
IRHF230	200	0.44	5.0	20	25	—	
M-pak — TO-254AA Package							<p>TO-254AA</p> 
IRHM150	100	0.065	25.0*	100	150	—	
IRHM250	200	0.100	25.0*	100	150	—	
IRHM450	500	0.45	11.5	40	150	—	
TO-3 Package							<p>TO-204AE (TO-3)</p> 
IRH150	100	0.055	30.0*	150	150	PD-9.478	
IRH250	200	0.100	27.0	110	150	PD-9.477	
IRH450	500	0.45	11.0	40	150	PD-9.479	

* Limited by package.

N.B. An Export License from the USA is required for Radiation Hard HEXFETs.